**Application No.: 10/687,701** 

## **CLAIMS**

This listing of claims will replace all prior versions, and listings of claims in the application.

(Previously presented) A method of washing a photomask comprising:
removing organic matter and metal impurities present on the surface of a photomask;
removing foreign matter adhering to said surface of said photomask with H<sub>2</sub> gas
dissolved water; and

drying said photomask,

wherein said photomask is a phase-shift mask including halftone mask, said H<sub>2</sub> gas dissolved water contains ammonia and the concentration of said ammonia is not more than 1%.

- 2. (Original) The method of washing a photomask in accordance with claim 1, wherein said H<sub>2</sub> gas dissolved water is alkalized.
- 3. (Original) The method of washing a photomask in accordance with claim 2, wherein said H<sub>2</sub> gas dissolved water is alkalized with ammonia.
- 4. (Original) The method of washing a photomask in accordance with claim 2, wherein said H<sub>2</sub> gas dissolved water is alkalized with KOH.
- 5. (Currently amended) The method of washing a photomask in accordance with claim 1, also employing ultrasonics waves in said second step of removing foreign matter.

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6. (Previously presented) The method of washing a photomask in accordance with claim 5, wherein said step of removing organic matter and metal impurities employs ultrasonics waves.

7. (Currently amended) The method of washing a photomask in accordance with claim 5, wherein said foreign matter if is particulate foreign matter.

## 8-14. (Cancelled)

15. (Previously presented) The method of washing a photomask in accordance with claim 1, wherein said phase-shift photomask is formed with an MoSiON film.